

N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified, high reliability
- Robust design
- Very low on-resistance $R_{DS(on)}$
- N-channel - Enhancement mode
- Halogen and Antimony Free(HAF), RoHS compliant

Applications

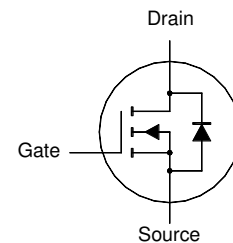
- Powertrain Management
- Electrical Power Steering
- Motor Drive
- Primary Switch for 12V System
- Industrial Automation
- Battery Protection



TOLL-8L
1.Gate(G)
2.3.4.5.6.7.8 Source(S)
9.Drain(D)

Key Parameters

Parameter	Value	Unit
BV_{DSS}	100	V
$R_{DS(ON)}$ Max	1.25 @ $V_{GS} = 10$ V	m Ω
	2.0 @ $V_{GS} = 4.5$ V	
Q_g typ	242 @ $V_{GS} = 10$ V	nC



Absolute Maximum Ratings(at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max	Max	Unit
Drain-Source Voltage	V_{DS}	100		V
Gate-Source Voltage	V_{GS}		± 20	V
Drain Current	I_D	$T_c = 25^\circ\text{C}$	300	A
		$T_c = 100^\circ\text{C}$	300	
Peak Drain Current, Pulsed ¹⁾	I_{DM}		1200	A
Continuous-Source Current	I_S		300	A
Single Pulse Avalanche Energy $V_{DD} = 50$ V , $L = 1$ mH	E_{AS}		1000	mJ
Power Dissipation	P_{tot}	$T_c = 25^\circ\text{C}$	600	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55	175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case ²⁾	$R_{\theta JC}$	0.25	$^\circ\text{C}/\text{W}$
Thermal Resistance from Junction to Ambient ²⁾	$R_{\theta JA}$	40	$^\circ\text{C}/\text{W}$

¹⁾Pulse width ≤ 300 μs , duty cycle ≤ 2 %

²⁾Surface Mounted on minimum footprint pad area

³⁾limited by bonding wire

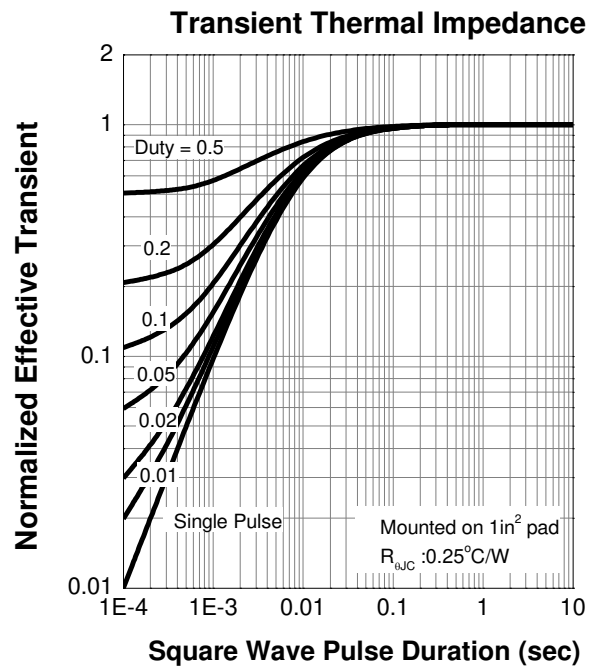
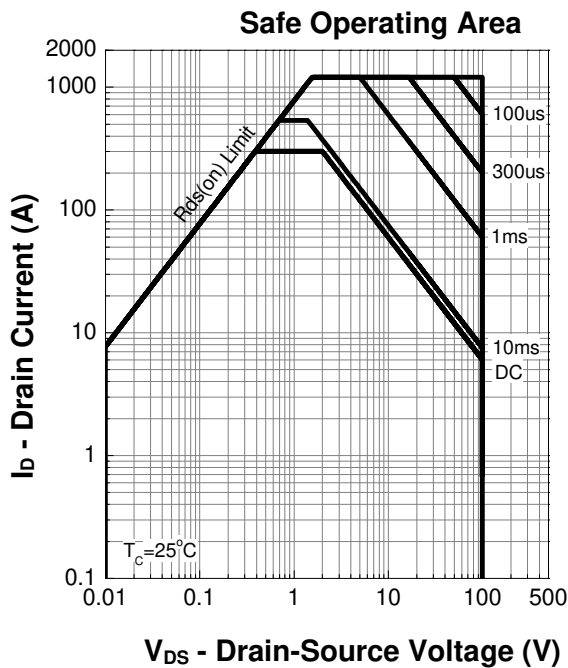
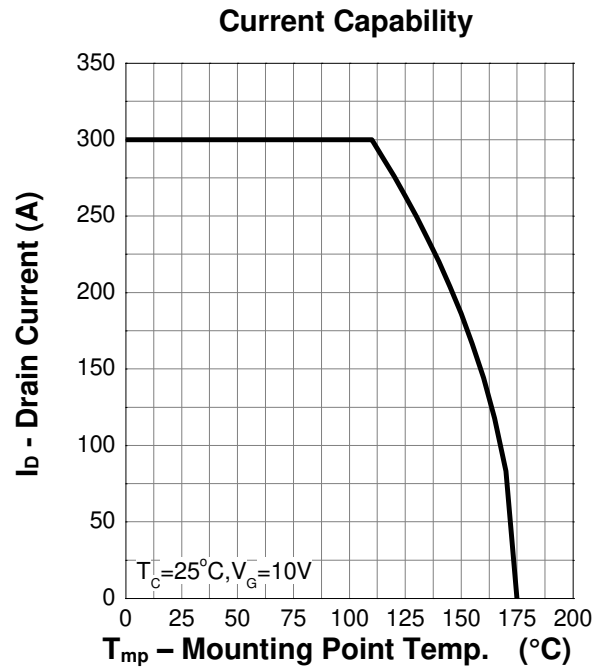
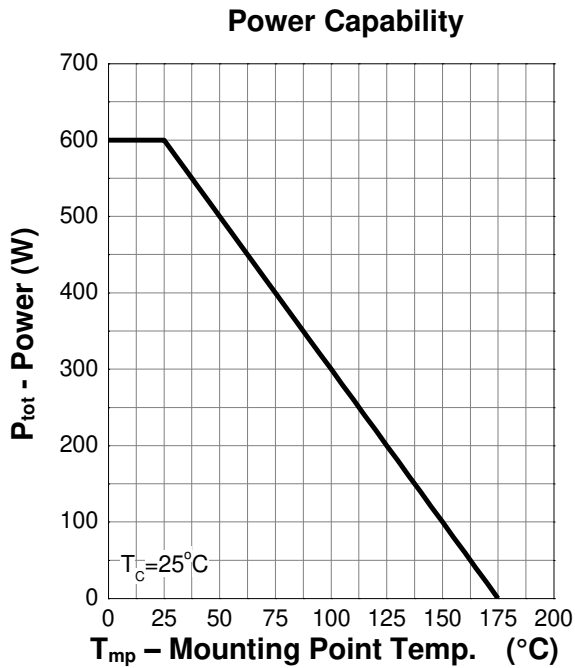
Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 250 \mu\text{A}$	BV_{DSS}	100	-	-	V
Drain-Source Leakage Current at $V_{DS} = 80 \text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 20 \text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}, I_{DS} = 250 \mu\text{A}$	$V_{GS(th)}$	1	-	3	V
Drain-Source On-State Resistance ¹⁾ at $V_{GS} = 10 \text{ V}, I_{DS} = 50 \text{ A}$ at $V_{GS} = 4.5 \text{ V}, I_{DS} = 25 \text{ A}$	$R_{DS(on)}$	-	1.1 1.5	1.25 2.0	$\text{m}\Omega$
DYNAMIC PARAMETERS ²⁾					
Input Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$	C_{iss}	-	12023	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$	C_{oss}	-	2071	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$	C_{rss}	-	89	-	pF
Gate charge total ²⁾ at $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	Q_g	-	242	--	nC
Gate to Source Charge at $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	Q_{gs}	-	46	-	nC
Gate to Drain Charge at $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	Q_{gd}	-	65	-	nC
Turn-On Delay Time at $V_{DS} = 50 \text{ V}, V_{GEN} = 10 \text{ V}, I_{DS} = 50 \text{ A}, R_g = 4.5 \Omega, R_L = 1\Omega$	$t_{d(on)}$	-	28	-	ns
Turn-On Rise Time at $V_{DS} = 50 \text{ V}, V_{GEN} = 10 \text{ V}, I_{DS} = 50 \text{ A}, R_g = 4.5 \Omega, R_L = 1\Omega$	t_r	-	107	-	ns
Turn-Off Delay Time at $V_{DS} = 50 \text{ V}, V_{GEN} = 10 \text{ V}, I_{DS} = 50 \text{ A}, R_g = 4.5 \Omega, R_L = 1\Omega$	$t_{d(off)}$	-	200	-	ns
Turn-Off Fall Time at $V_{DS} = 50 \text{ V}, V_{GEN} = 10 \text{ V}, I_{DS} = 50 \text{ A}, R_g = 4.5 \Omega, R_L = 1\Omega$	t_f	-	177	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage ¹⁾ at $I_S = 50 \text{ A}, V_{GS} = 0 \text{ V}$	V_{SD}	-	-	1.3	V
Body Diode Reverse Recovery Time at $I_{DS} = 50 \text{ A}, di_{SD}/dt = 100 \text{ A} / \mu\text{s}$	t_{rr}	-	137	-	ns
Body Diode Reverse Recovery Charge at $I_{DS} = 50 \text{ A}, di_{SD}/dt = 100 \text{ A} / \mu\text{s}$	Q_{rr}	-	347	-	nC

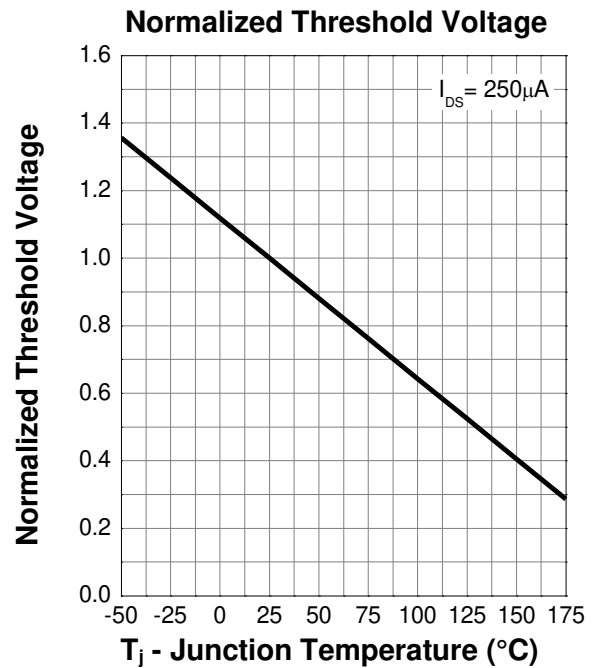
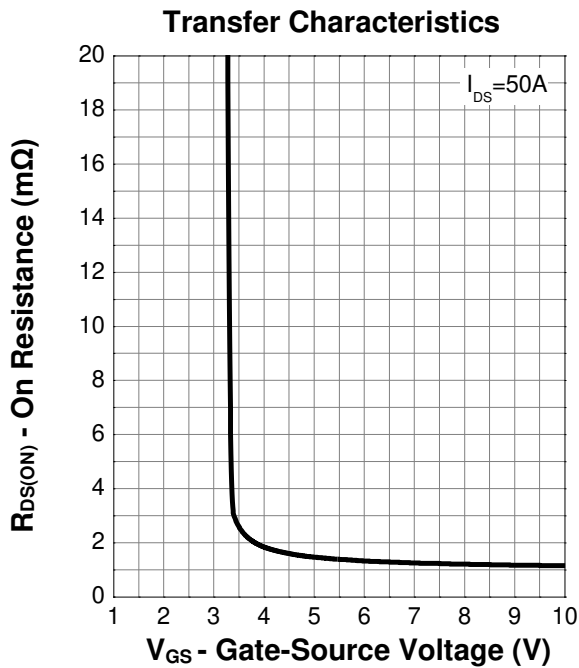
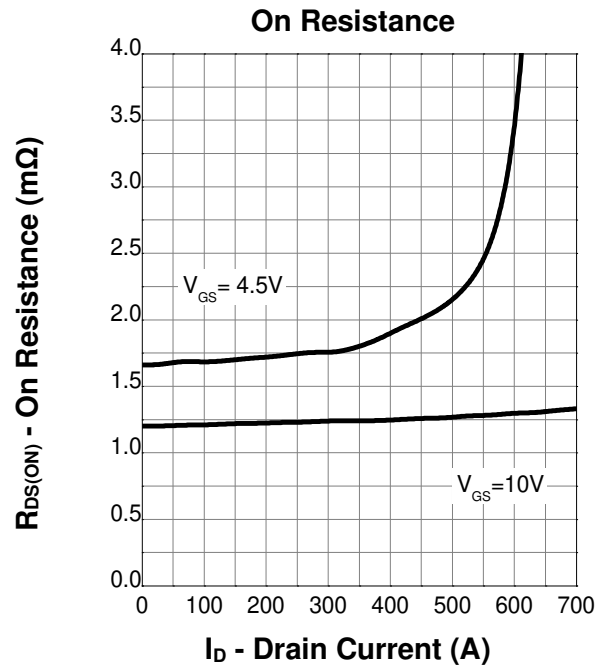
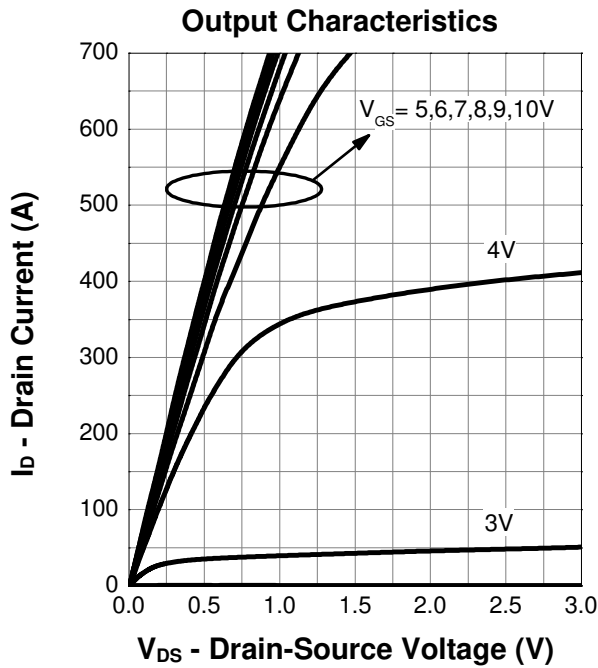
Notes:

¹⁾Pulse test ; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$
²⁾Guaranteed by design, not subject to production testing

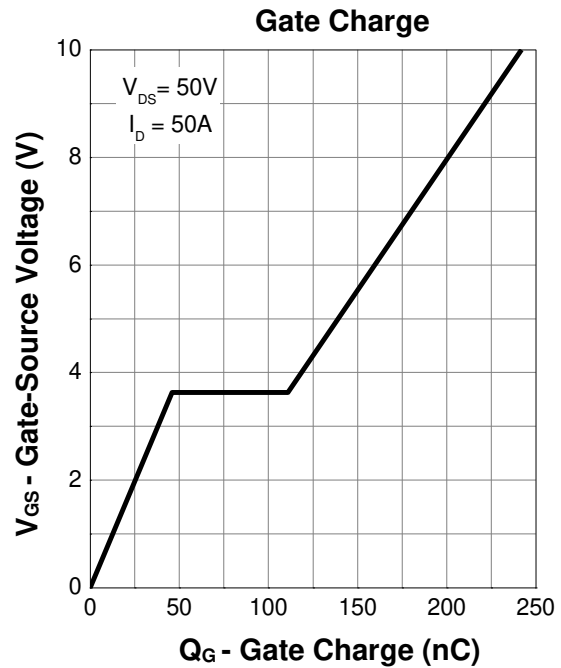
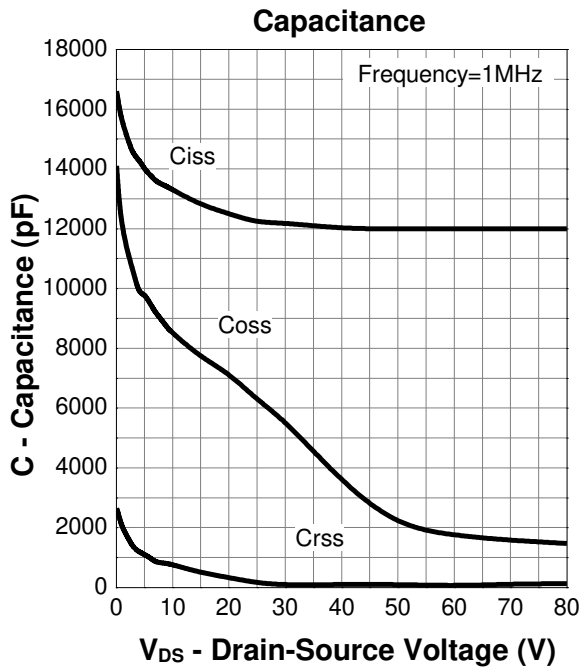
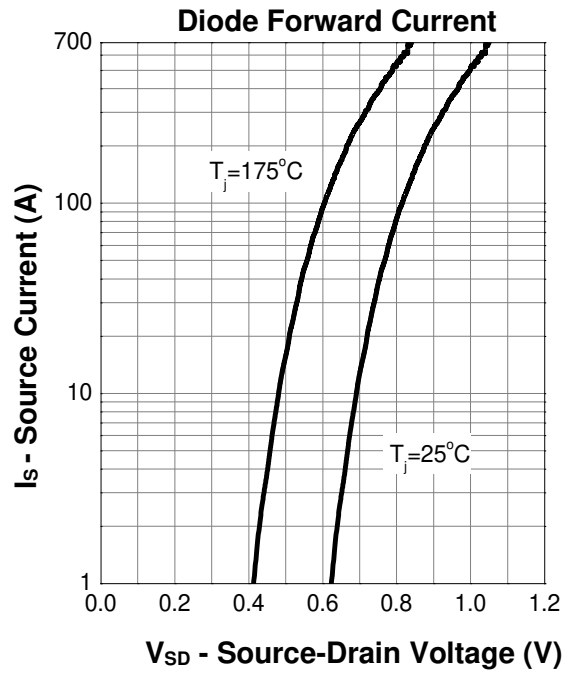
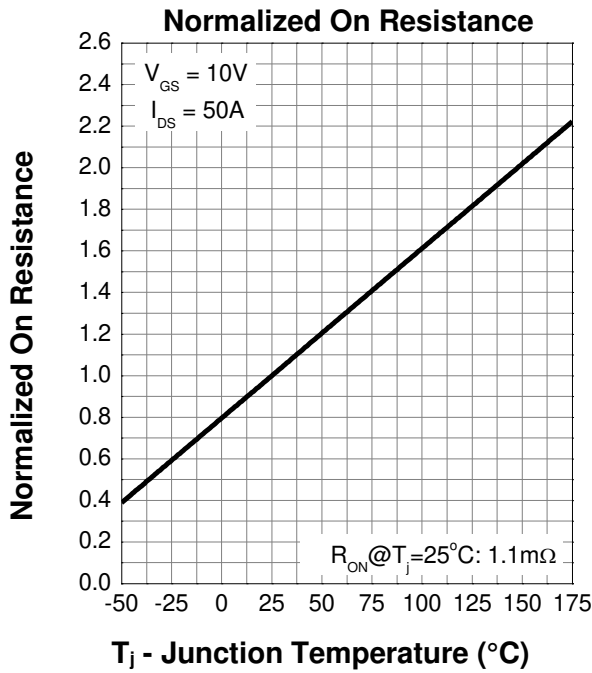
Typical Characteristics



Typical Characteristics (cont.)

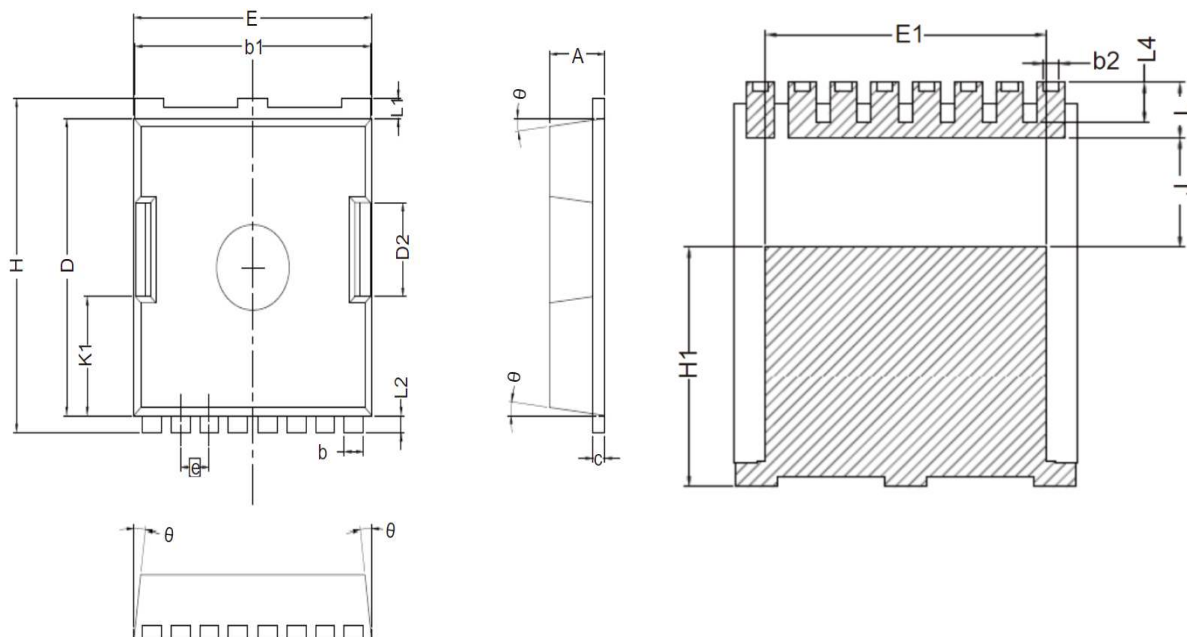


Typical Characteristics (cont.)



Package Dimensions

TOLL-8L



UNIT	A	b	b1	b2	c	D	D2	E	E1	e
mm	2.2	0.9	9.7	0.42	0.42	10.28	3.10	9.70	7.90	1.20
	2.4	0.9	9.9	0.50	0.60	10.58	3.50	10.10	8.30	BSC

H	H1	J	K1	L	L1	L2	L4	θ
11.48	6.75	3.00	3.98	1.40	0.60	0.50	1.00	4°
11.88	7.15	3.30	4.38	1.80	0.80	0.70	1.30	10°

Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
TOLL-8L	24	4	0.1575	330	12.99	2000

Marking information

" DG10N012LSA " = Part No.

" ***** " = Date Code Marking

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